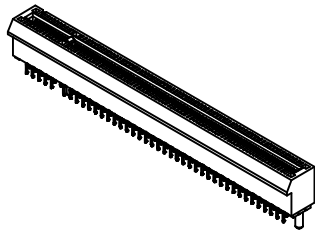
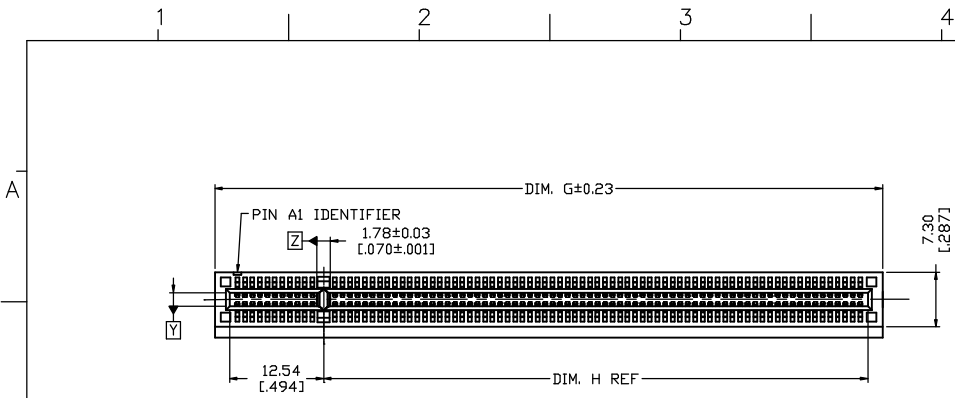
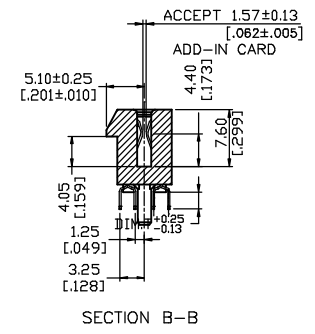
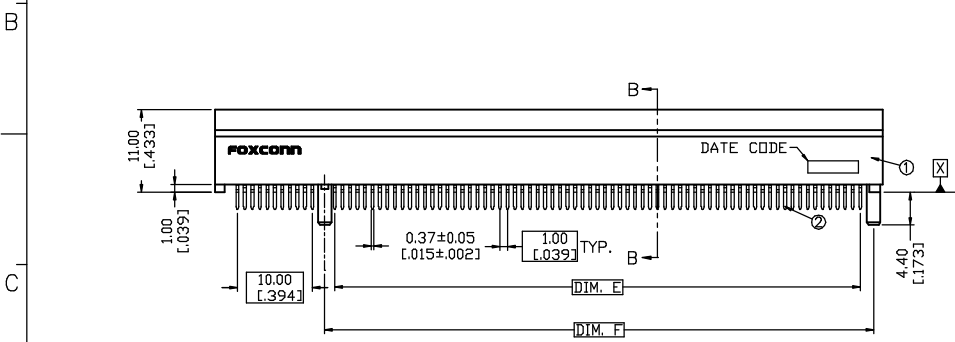


REV.	ECN.	NO.	APPD.
A	BC05712007		Wen-Guey Lii
B	BC05725833		Wen-Guey Lii
C	BC-07-7077392		C.C. Huang



- NOTES:
- ELECTRICAL CHARACTERISTICS:
    - 1-1 CURRENT RATING: 1.1 A MIN., 30°C RISE ABOVE AMBIENT.
    - 1-2 CONTACT RESISTANCE: 30 MILLIOHMS MAX. INITIAL, 50 MILLIOHMS MAX. AFTER TEST.
    - 1-3 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
    - 1-4 DIELECTRICAL WITHSTAND VOLTAGE: 500 V AC MIN. AT SEA LEVEL.
  - MECHANICAL CHARACTERISTICS:
    - 2-1 CONTACT INSERTION FORCE: 1.15 N MAX. PER CONTACT PAIR.
    - 2-2 CONTACT REMOVAL FORCE: 0.15 N MIN. PER CONTACT PAIR.
    - 2-3 DURABILITY: 50 MATING AND UNMATING CYCLES.
    - 2-4 CONTACT RETENTION FORCE: 4.9 N MIN.
  - ENVIRONMENTAL CHARACTERISTICS:
    - 3-1 OPERATING TEMPERATURE RANGE: -40°C TO +105°C.
  - PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCTION DETAILS & AVAILABILITY
  - RECOMMENDED PROCESS CONDITION: WAVE SOLDER, 260°C, 3~5 S.



PROD. NO.: 2EG 0 \*\* \* \*-D2D- \*\*

FIELD PRODUCT SERIES: 2EG= PCI EXPRESS

TERMINAL TYPE: 0= VERTICAL TYPE

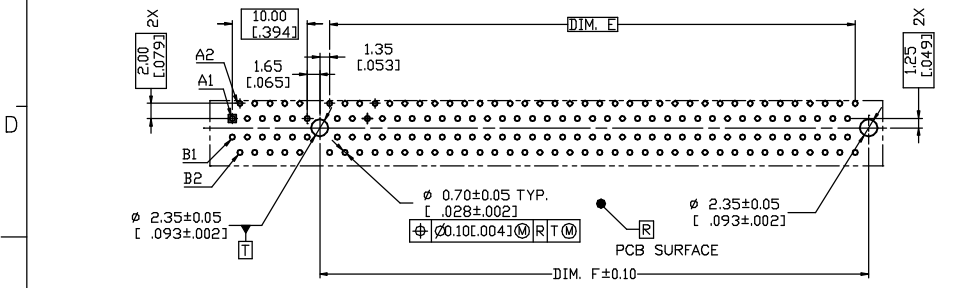
NO. OF POS.  
 18= 36 POSITIONS  
 32= 64 POSITIONS  
 49= 98 POSITIONS  
 82= 164 POSITIONS

PLATING TYPE:  
 DF= Lead Free  
 RoHS COMPLIANT

EXTENSION CODE

CONTACT AREA GOLD PLATING:  
 1= GOLD FLASH  
 7= 15u" GOLD  
 3= 30u" GOLD

TAIL LENGTH:  
 1= 2.30mm  
 2= 3.10mm



RECOMMENDED PCB LAYOUT

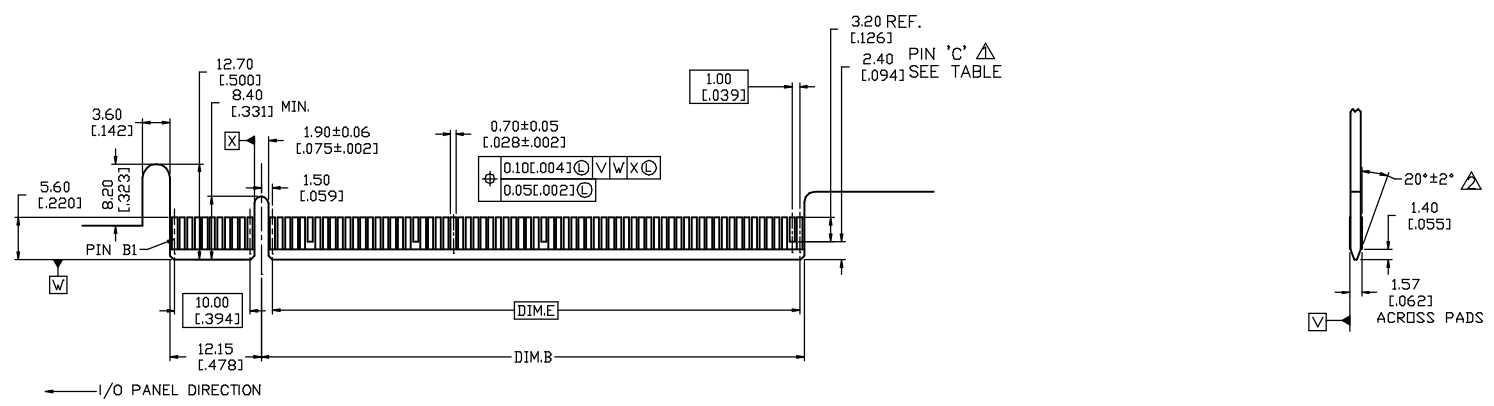
2EG082**-D2D- **	70.00	73.15	89.00	72.54
2EG049**-D2D- **	37.00	40.15	56.00	39.54
2EG032**-D2D- **	20.00	23.15	39.00	22.54
2EG018**-D2D- **	6.00	9.15	25.00	8.54
PART NUMBER	DIM. E	DIM. F	DIM. G	DIM. H

ITEM	DESCRIPTION	MATERIAL	TREATMENT
2	CONTACT	COPPER ALLOY	50u" MIN. NICKEL PLATING OVERALL UNDERPLATED. 100u" MIN. TIN PLATING OVER NICKEL AT TAIL , GOLD PLATING ON CONTACT AREA.
1	HOUSING	THERMOPLASTIC UL 94V-0	MOLDED BLACK

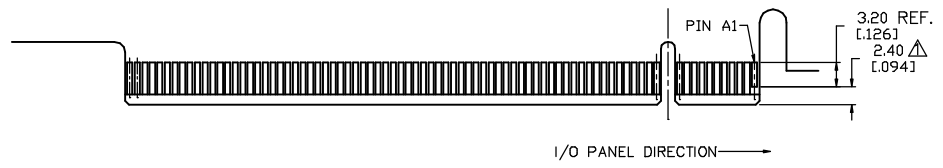
  

UNITS	NAME (INTENDED USE)	FOXCONN
X. ±	X. ° ±	HON HAI PRECISION IND. CO., LTD. TAIPEI, TAIWAN, R.O.C.
.X ±	.X ° ±	TITLE: PCI-EXPRESS CUSTOMER DRAWING
.XX ±	.XX ° ±	
.XXX ±	.XXX ° ±	APPD: C.C. Huang 11/16'07
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF HON HAI PRECISION IND. CO., LTD. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF HON HAI PRECISION IND. CO., LTD.		
Q'TY	CHKD: Tin-Suen Liu 11/16'07	DWG NO.: 303-0000-1368
	DR: W.J Tang 11/16'07	SCALE SHEET REV. N/A 1/2 C

REV.	ECN. NO.	NO.	APPD.
SEE SHEET 1/2			



PRIMARY (COMPONENT) SIDE



SECONDARY (SOLDER) SIDE

ADD-IN CARD EDGE-FINGER DIMENSIONS

2EG082**-D2D-***	72.15	70.00	164/16X	B81
2EG049**-D2D-***	39.15	37.00	98/8X	B48
2EG032**-D2D-***	22.15	20.00	64/4X	B31
2EG018**-D2D-***	8.15	6.00	36/1X	B17
PART NUMBER	DIM. B	DIM. E	NO PDS /WAY	C

NOTES:

- △ NO TIE PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND 'C'.
- △ CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.

X. ±	X°. ±	UNITS	mm INCH	NAME (INTENDED USE)	<b>FOXCONN</b> HON HAI PRECISION IND. CO., LTD. TAIPEI, TAIWAN, R.O.C.
.X ± 0.25 [.010]	.X°. ±	MAT'L	N/A	Vertical, T/H	
.XX ± 0.13 [.005]	.XX°. ±	FINISH	N/A	PART NO. (INTENDED USE)	TITLE: PCI-EXPRESS CUSTOMER DRAWING
.XXX ±	.XXX°. ±	Q'TY	N/A	APPD: C.C. Huang 11/16'07	DWG NO.: 303-0000-1368
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				DR: W.J Tang 11/16'07	